74LVC16374A; 74LVCH16374A

16-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state

Rev. 11 — 16 January 2013

Product data sheet

1. General description

The 74LVC16374A and 74LVCH16374A are 16-bit edge-triggered flip-flops featuring separate D-type inputs with bus hold (74LVCH16374A only) for each flip-flop and 3-state outputs for bus-oriented applications. It consists of two sections of eight positive edge-triggered flip-flops. A clock input (nCP) and an output enable (nOE) are provided for each octal.

The flip-flops store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (CP) transition.

When pin nOE is LOW, the contents of the flip-flops are available at the outputs. When pin nOE is HIGH, the outputs go to the high-impedance OFF-state. Operation of input nOE does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

Bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pinout architecture
- Low inductance multiple supply pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold (74LVCH16374A only)
- High-impedance outputs when V_{CC} = 0 V
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

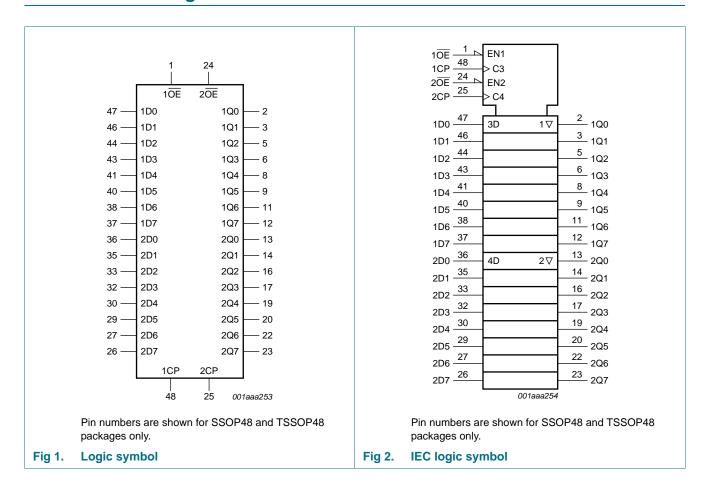


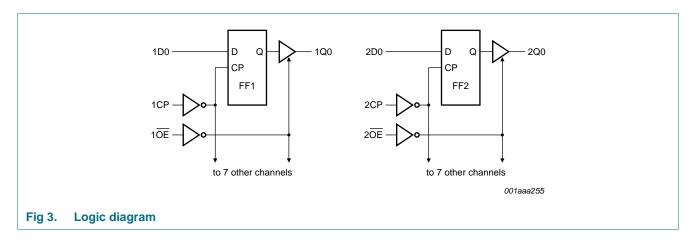
3. Ordering information

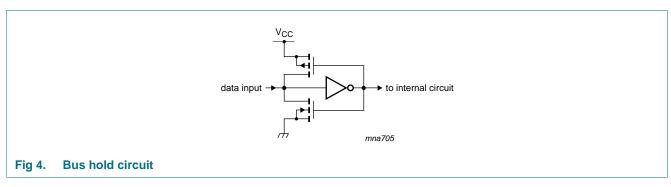
Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC16374ADL	−40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads;	SOT370-1
74LVCH16374ADL			body width 7.5 mm	
74LVC16374ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1
74LVCH16374ADGG			48 leads; body width 6.1 mm	
74LVC16374ABX	–40 °C to +125 °C	HXQFN60U	plastic thermal enhanced extremely thin quad flat	SOT1134-1
74LVCH16374ABX			package; no leads; 60 terminals; UTLP based; body $4 \times 6 \times 0.5$ mm	

4. Functional diagram

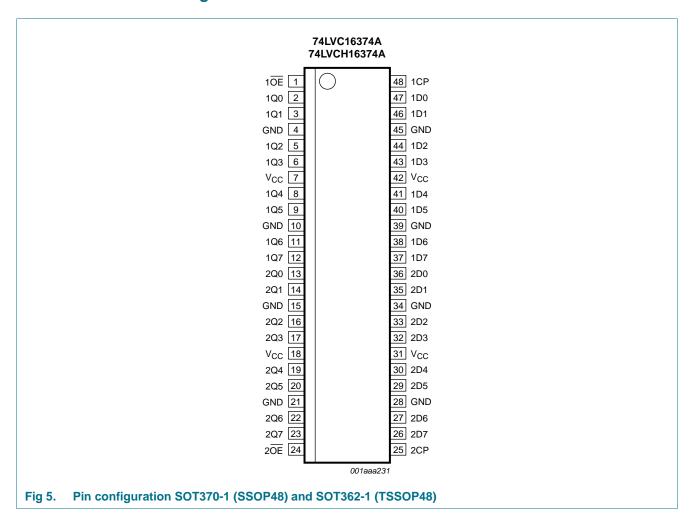


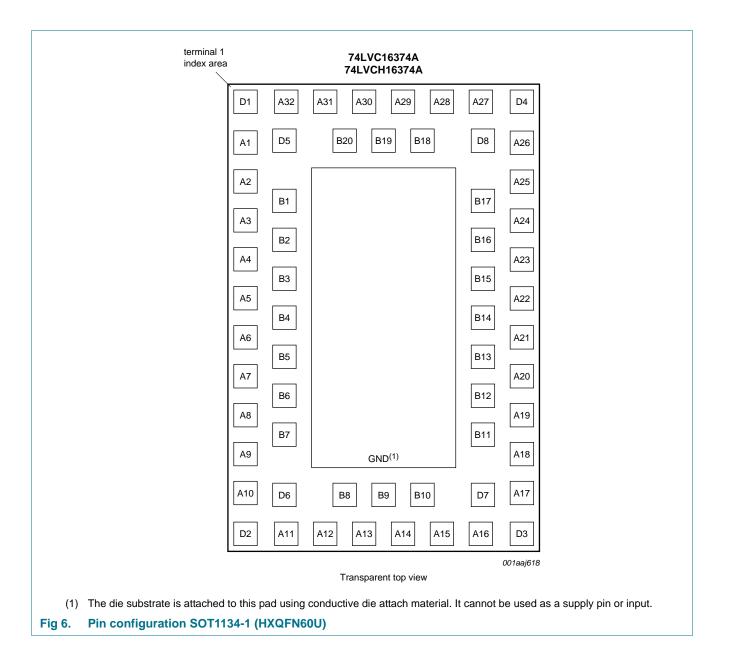




5. Pinning information

5.1 Pinning





74LVC LVCH16374A

5.2 Pin description

Table 2. Pin description

Symbol	Pin		Description	
	SOT370-1 and SOT362-1	SOT1134-1	-	
10E, 20E	1, 24	A30, A13	output enable input (active LOW)	
GND	4, 10, 15, 21, 28, 34, 39, 45	A32, A3, A8, A11, A16, A19, A24, A27	ground (0 V)	
V _{CC}	7, 18, 31, 42	A1, A10, A17, A26	supply voltage	
1Q0 to 1Q7	2, 3, 5, 6, 8, 9, 11, 12	B20, A31, D5, D1, A2, B2, B3, A5	data output	
2Q0 to 2Q7	13, 14, 16, 17, 19, 20, 22, 23	A6, B5, B6, A9, D2, D6, A12, B8	data output	
1D0 to 1D7	47, 46, 44, 43, 41, 40, 38, 37	B18, A28, D8, D4, A25, B16, B15, A22	data input	
2D0 to 2D7	36, 35, 33, 32, 30, 29, 27, 26	A21, B13, B12, A18, D3, D7, A15, B10	data input	
1CP, 2CP	48, 25	A29, A14	clock input	

6. Functional description

Table 3. Function selection[1]

Operating mode	Input			Internal flip-flop	Output nQ0 to nQ7
	nOE	nCP	nDn		
Load and read register	L	↑	l	L	L
	L	↑	h	Н	Н
Load register and disable outputs	Н	↑	I	L	Z
	Н	↑	h	Н	Z

^[1] H = HIGH voltage level;

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
Vo	output voltage	output HIGH-or LOW-state	<u>[2]</u> -0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> -0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C

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h = HIGH voltage level one set-up time prior to the HIGH-to-LOW CP transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the HIGH-to-LOW CP transition;

^{↑ =} LOW-to-HIGH transition;

Z = high-impedance OFF-state.

Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot} total power dissipation		$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$			
		(T)SSOP48 package	<u>[3]</u> _	500	mW
		HXQFN60U package	<u>[4]</u> _	1000	mW

- [1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.
- [2] The output voltage ratings may be exceeded if the output current ratings are observed.
- [3] Above 60 °C, the value of Ptot derates linearly with 5.5 mW/K.
- [4] Above 70 °C, the value of P_{tot} derates linearly with 1.8 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V_{I}	input voltage		0	-	5.5	V
Vo	output voltage	active mode	0	-	V_{CC}	V
		power-down mode; $V_{CC} = 0 \text{ V}$	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	–40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V_{IL}	LOW-level	$V_{CC} = 1.2 \text{ V}$	-	-	0.12	-	0.12	V
	input voltage	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V

 Table 6.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	S °C	-40 °C to	+125 °C	Uni
			Min	Typ[1]	Max	Min	Max	
/он	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.2	V_{CC}	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}$; $V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
√ _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	0	0.2	-	0.3	V
		$I_O = 4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
l	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$ [2]	-	±0.1	±5	-	±20	μΑ
OZ	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ $V_O = 5.5 \text{ V or GND } \boxed{2}$	-	±0.1	±5	-	±20	μА
OFF	power-off leakage current	$V_{CC} = 0 \text{ V}; \text{ V}_{I} \text{ or } \text{V}_{O} = 5.5 \text{ V}$	-	±0.1	±10	-	±20	μА
CC	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.1	20	-	80	μΑ
7l ^{CC}	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_I = V_{CC} - 0.6 \text{ V};$ $I_O = 0 \text{ A}$	-	5	500	-	5000	μА
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF
BHL	bus hold	$V_{CC} = 1.65$; $V_I = 0.58 \text{ V} \frac{[3][4]}{}$	10	-	-	10	-	μΑ
	LOW current	$V_{CC} = 2.3; V_I = 0.7 V$	30	-	-	25	-	μΑ
		$V_{CC} = 3.0$; $V_I = 0.8 \text{ V}$	75	-	-	60	-	μΑ
ВНН	bus hold	$V_{CC} = 1.65$; $V_I = 1.07 \text{ V} \frac{[3][4]}{}$	-10	-	-	-10	-	μΑ
	HIGH current	$V_{CC} = 2.3; V_I = 1.7 V$	-30	-	-	-25	-	μΑ
		$V_{CC} = 3.0; V_I = 2.0 \text{ V}$	-75	-	-	-60	-	μΑ
BHLO	bus hold	V _{CC} = 1.95 V [3][5]	200	-	-	200	-	μΑ
	LOW	V _{CC} = 2.7 V	300	-	-	300	-	μΑ
	overdrive current	V _{CC} = 3.6 V	500	-	-	500	-	μΑ

Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	–40 °C to +85 °C			-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
I _{BHHO}	bus hold	V _{CC} = 1.95 V [3][5]	-200	-	-	-200	-	μΑ
	HIGH overdrive	V _{CC} = 2.7 V	-300	-	-	-300	-	μΑ
	current	$V_{CC} = 3.6 \text{ V}$	-500	-	-	-500	-	μΑ

- [1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.
- [2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input pin.
- [3] Valid for data inputs (74LVCH16374A) only; control inputs do not have a bus hold circuit.
- [4] The specified sustaining current at the data inputs holds the input below the specified V_I level.
- [5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation	nCP to nQn; see Figure 7	[2]		'		'		
	delay	V _{CC} = 1.2 V		-	14	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.1	6.9	13.5	2.1	15.6	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.7	6.7	1.5	7.7	ns
		$V_{CC} = 2.7 V$		1.5	3.4	6.0	1.5	7.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.1	5.4	1.5	7.0	ns
t _{en}	enable time	nOE to nQn; see Figure 9	[2]						
		V _{CC} = 1.2 V		-	20	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	5.9	13.1	1.5	15.1	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.4	6.9	1.5	8.0	ns
		$V_{CC} = 2.7 V$		1.5	3.6	6.0	1.5	7.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.7	5.2	1.0	6.5	ns
t _{dis}	disable time	nOE to nQn; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	12	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.8	4.6	9.1	2.8	10.5	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.5	4.9	1.0	5.7	ns
		$V_{CC} = 2.7 V$		1.5	3.4	5.1	1.5	6.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.1	4.9	1.5	6.5	ns
t _W	pulse width	nCP HIGH; see Figure 7							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		5.0	-	-	5.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		3.0	-	-	3.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		3.0	1.5	-	3.0	-	ns

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{su}	set-up time	nDn to nCP; see Figure 8	'				•	'	
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		3.0	-	-	3.0	-	ns
		V _{CC} = 2.7 V		1.9	-	-	1.9	-	ns
		V _{CC} = 3.0 V to 3.6 V		1.9	0.3	-	1.9	-	ns
t _h	hold time	nDn to nCP; see Figure 8							
		V _{CC} = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		V _{CC} = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		V _{CC} = 2.7 V		1.1	-	-	1.1	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		+1.5	-0.3	-	1.5	-	ns
f _{max}	maximum	see Figure 7							
	frequency	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		100	-	-	80	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		125	-	-	100	-	ns
		V _{CC} = 2.7 V		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		150	300	-	120	-	MHz
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	dissipation	V _{CC} = 1.65 V to 1.95 V		-	14.1	-	-	-	pF
	capacitance	V _{CC} = 2.3 V to 2.7 V		-	16.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	18.5	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

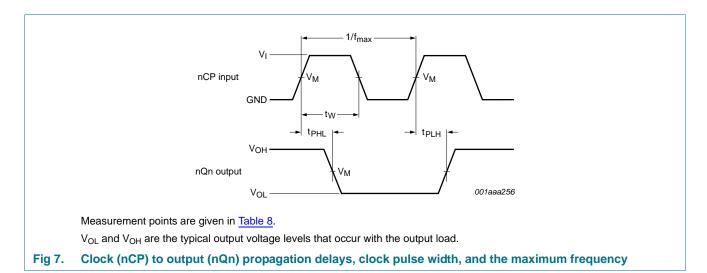
N = number of inputs switching

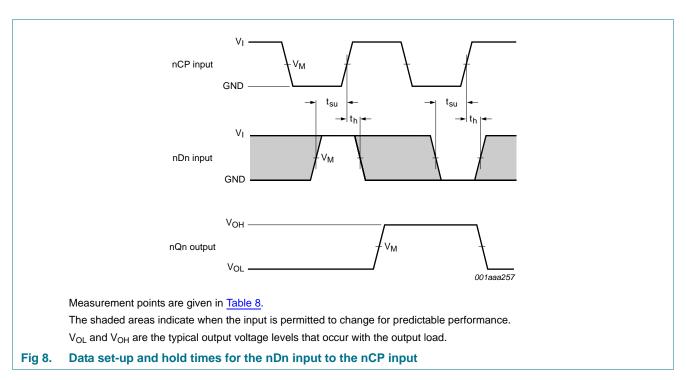
 $\Sigma (C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs

 $[\]begin{array}{ll} \hbox{ [2]} & t_{pd} \hbox{ is the same as } t_{PLH} \hbox{ and } t_{PHL}. \\ \\ & t_{en} \hbox{ is the same as } t_{PZL} \hbox{ and } t_{PZH}. \end{array}$

^[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

11. Waveforms





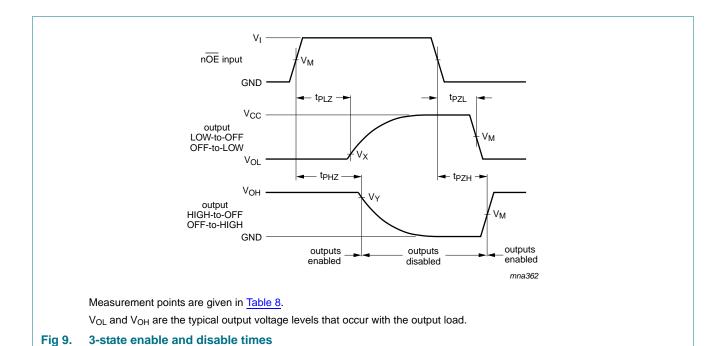
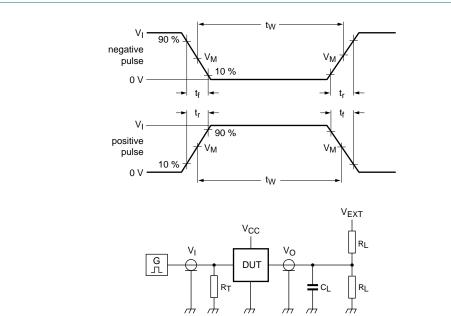


Table 8. Measurement points

Supply voltage	Input		Output				
V _{CC}	VI	V _M	V _M	V _X	V _Y		
1.2 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	$V_{OH}-0.15\ V$		
1.65 V to 1.95 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
2.3 V to 2.7 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	$V_{OH} - 0.3 V$		
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 V$	$V_{OH} - 0.3 V$		

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16-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state



Test data is given in Table 9.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

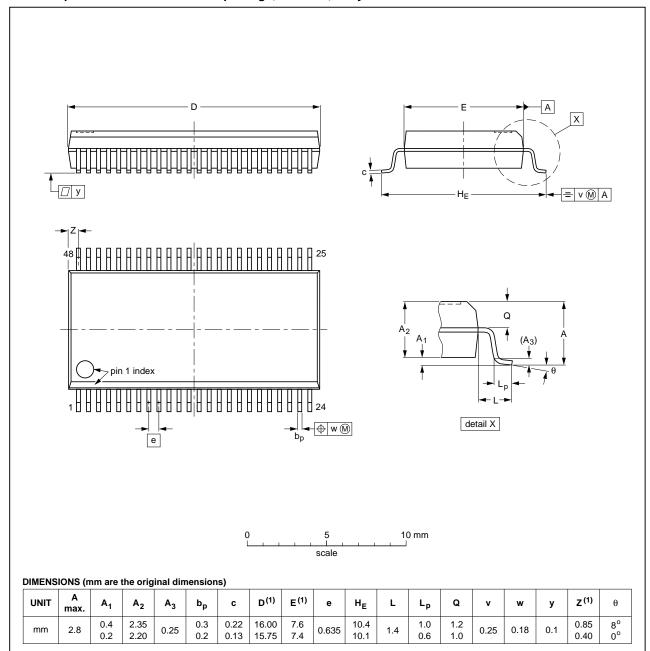
Table 9. Test data

Supply voltage	Input		Load		V _{EXT}	V _{EXT}			
	VI	t _r , t _f	CL	R_L	t _{PLH} , t _{PHL}	t_{PLZ}, t_{PZL}	t _{PHZ} , t _{PZH}		
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 k Ω	open	$2\times V_{CC}$	GND		
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND		
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2 \times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND		

12. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	IOOUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT370-1		MO-118				99-12-27 03-02-19	

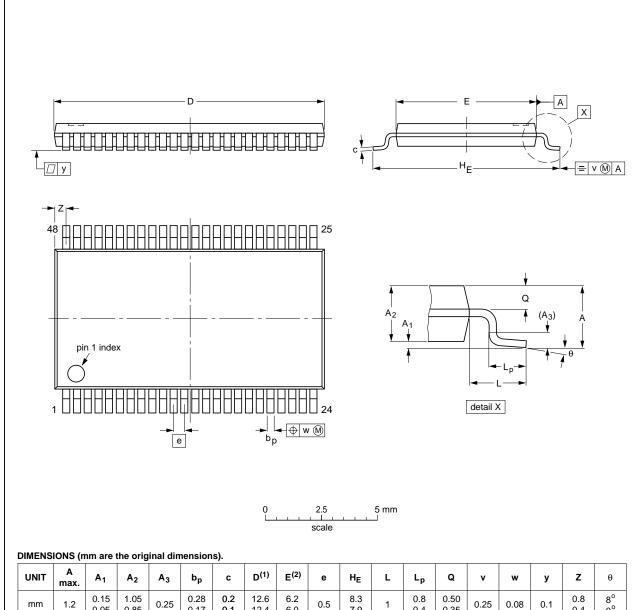
Fig 11. Package outline SOT370-1 (SSOP48)

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TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT362-1		MO-153				99-12-27 03-02-19
					1	03-02-18

Fig 12. Package outline SOT362-1 (TSSOP48)

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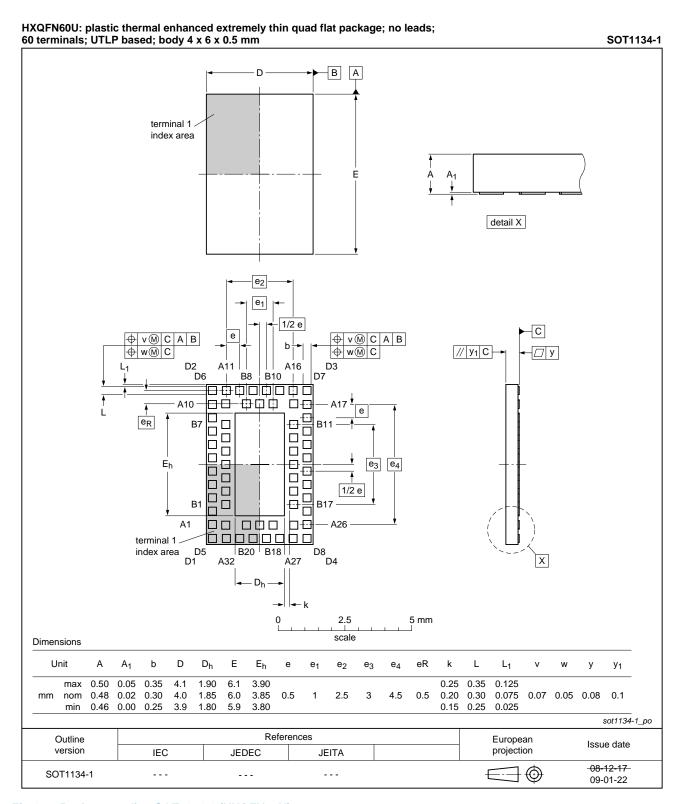


Fig 13. Package outline SOT1134-1 (HXQFN60U)

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13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

	<u>, </u>			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH16374A v.11	20130116	Product data sheet	-	74LVC_LVCH16374A v.10
Modifications:	 Minor non- 	technical text changes and	d corrections	
	 Document 	revision history correction		
74LVC_LVCH16374A v.10	20120301	Product data sheet	-	74LVC_LVCH16374A v.9
74LVC_LVCH16374A v.9	20111219	Product data sheet	-	74LVC_LVCH16374A v.8
74LVC_LVCH16374A v.8	20110621	Product data sheet	-	74LVC_LVCH16374A v.7
74LVC_LVCH16374A v.7	20100323	Product data sheet	-	74LVC_LVCH16374A v.6
74LVC_LVCH16374A v.6	20090212	Product data sheet	-	74LVC_LVCH16374A v.5
74LVC_LVCH16374A v.5	20031212	Product specification	-	74LVC_H16374A v.4
74LVC_H16374A v.4	19980317	Product specification	-	74LVC16374A_ 74LVCH16374A v.3
74LVC16374A_ 74LVCH16374A v.3	19980317	Product specification	-	74LVC16374A v.2
74LVC16374A v.2	19970822	Product specification	-	74LVC16374A v.1
74LVC16374A v.1	-	-	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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16-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state

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NXP Semiconductors

16-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state

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